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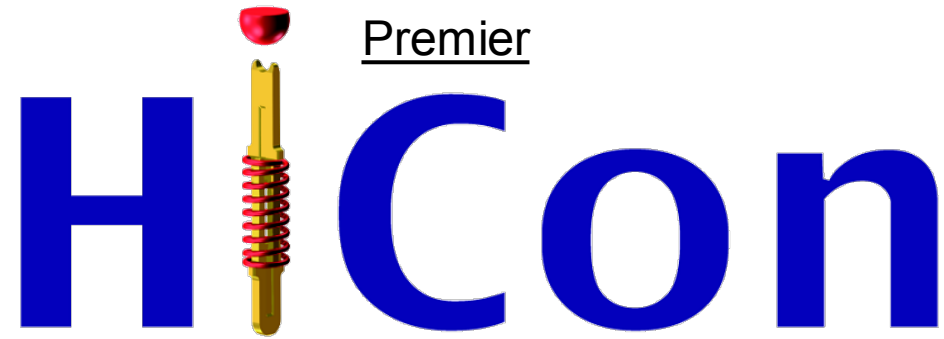
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Utilizing System Level Test to Achieve High-throughput, Automated RF Testing

John Toscano
Teradyne



TestConX 2023

Contents

- IC device trends and challenges
- Utilizing RF +SLT to address the new challenges
- Combining traditional SLT with RF calibration and verification
- Elements of an SLT RF system
 - Integrated instruments
 - High repeatability RF interconnect
 - Signal splitter for multiple antennas
 - Shielding
 - Calibration
- Emerging applications



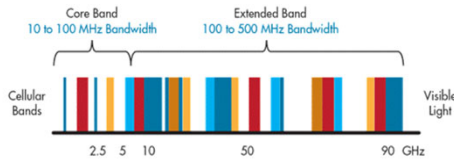
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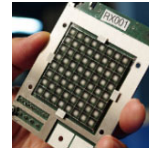
Wireless Industry Trend

Emerging Requirements



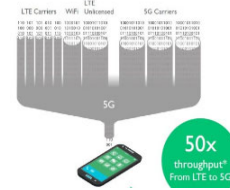
Higher Frequencies (mmWave)
Wider Bandwidths

Device Complexity

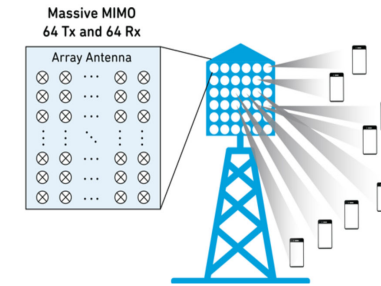


Beamforming
Arrays

Carrier
Aggregation



mMIMO



"BTS mMIMO Multiplier"

New Applications



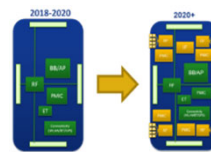
Micro-Location

Automotive
Connectivity

L3-L5 ADAS
mmW



Increasing Volumes



"mmWave Multiplier"



Small Cells

Cell Type	Data Throughput	Cell Radius	Power	Location
Macro Cell	100-1000	1000-10000	10-100	Macro
Micro Cell	10-100	100-1000	1-10	Micro
Pico Cell	1-10	10-100	0.1-1	Pico

Heterogeneous Connectivity

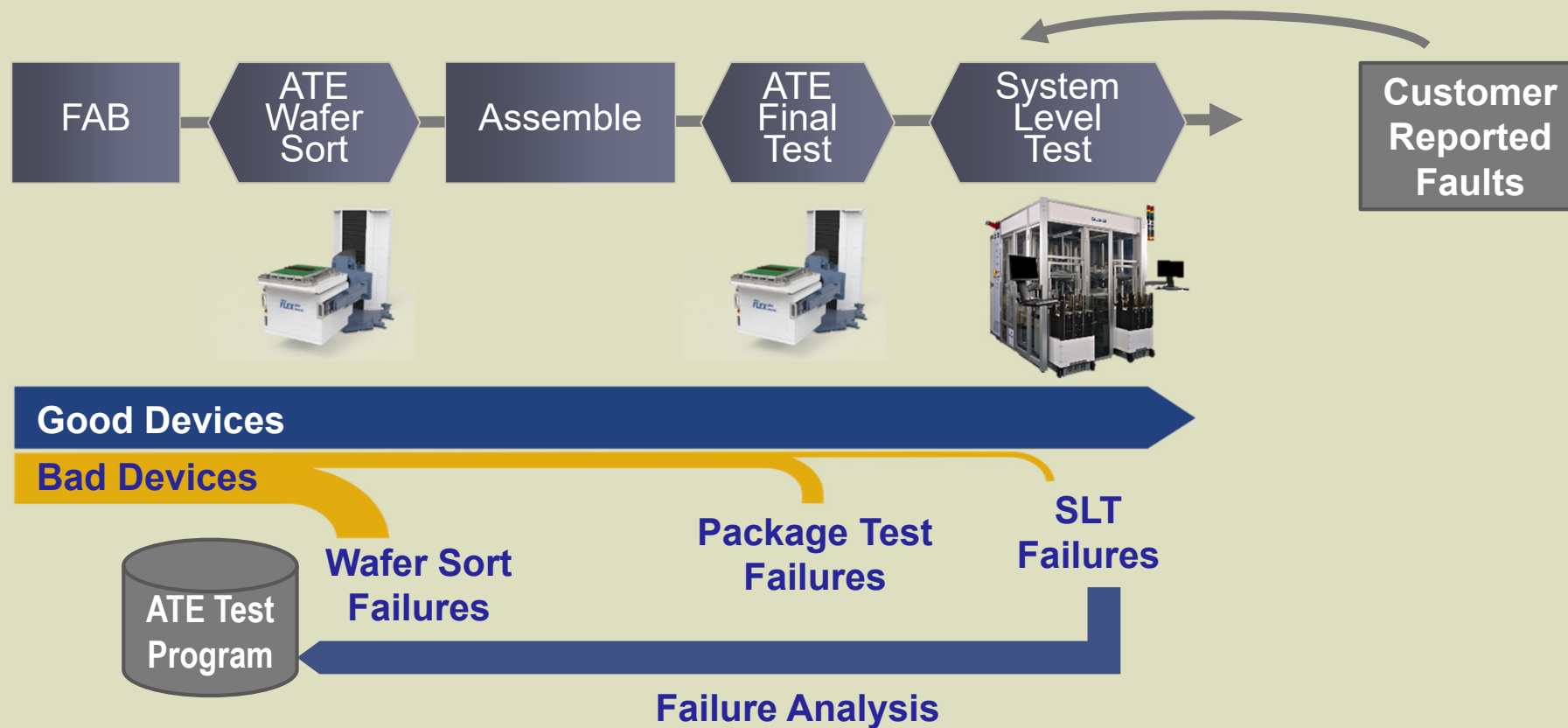


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SLT Role in Failure Analysis



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SLT/RF Platform Key Considerations

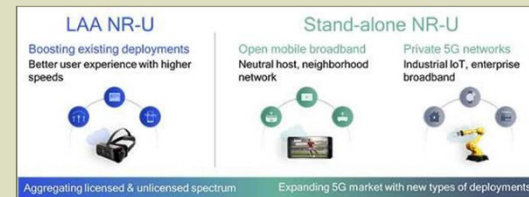
Key considerations for SLT

- Asynchronous testing is critical to reducing the cost of test
- Optimize uptime and utilization rate to increase operating efficiency
- Compact floor space to save operating cost



Key considerations for RF instrument

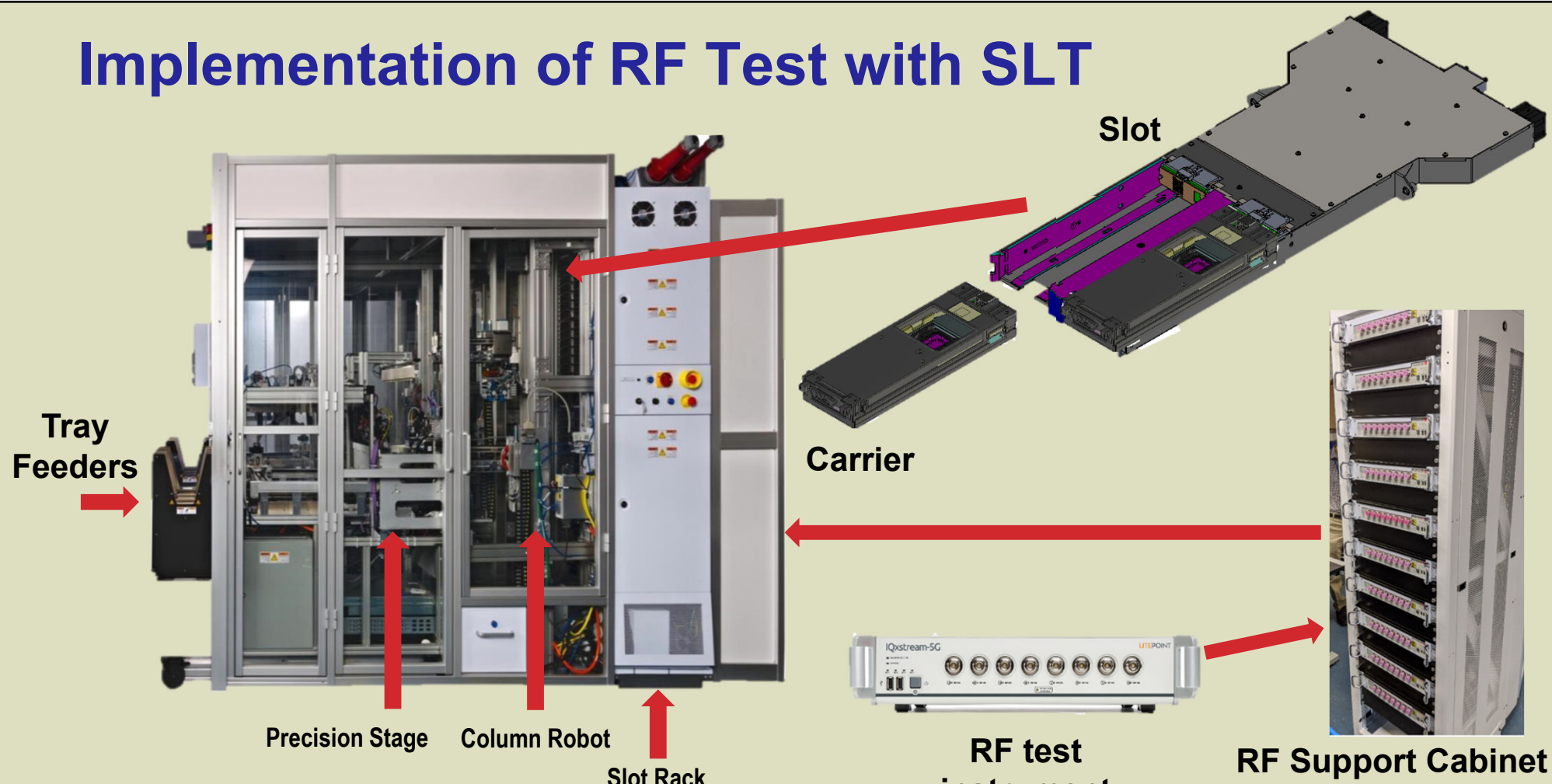
- Cover the frequency bands required by your device and roadmap
- High density instrument architecture
- Instrument resource sharing capability
- High output signal power to overcome fixture losses



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Implementation of RF Test with SLT



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Utilizing SLT RF Test to Reduce Field Failures

Utilize SLT to achieve high-throughput, automated RF Testing:

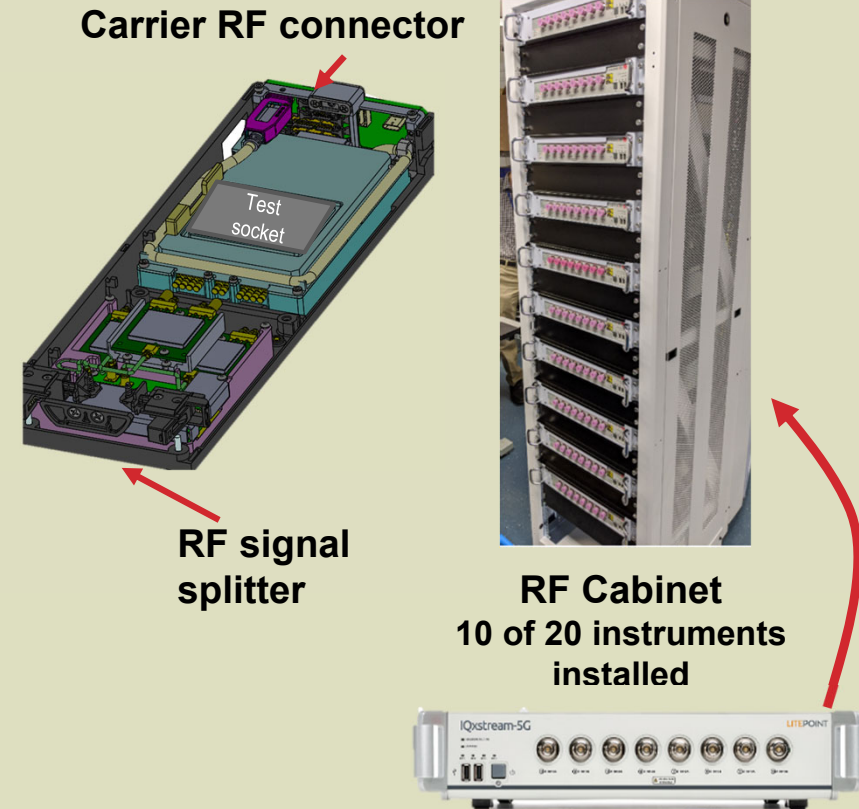
- Easy to create operation-mode functional tests which can be challenging to do in ATE
- Finds faults missed by traditional ATE

Integrated RF Test for SLT:

- Integrated automated SLT system with RF instruments
- Use RF instrument function calls in the Test Program
- Connect with dedicated or shared RF resource
- High-reliability connector carrier to slot

Application example with SLT and RF

- Frequency range **400MHz to 6GHz***
- **-25dBm** power delivery to all ports*
- Power level accuracy **+/- 1.5 dB (k=3)**
- **>60 dB** site-to-site shielding effectiveness



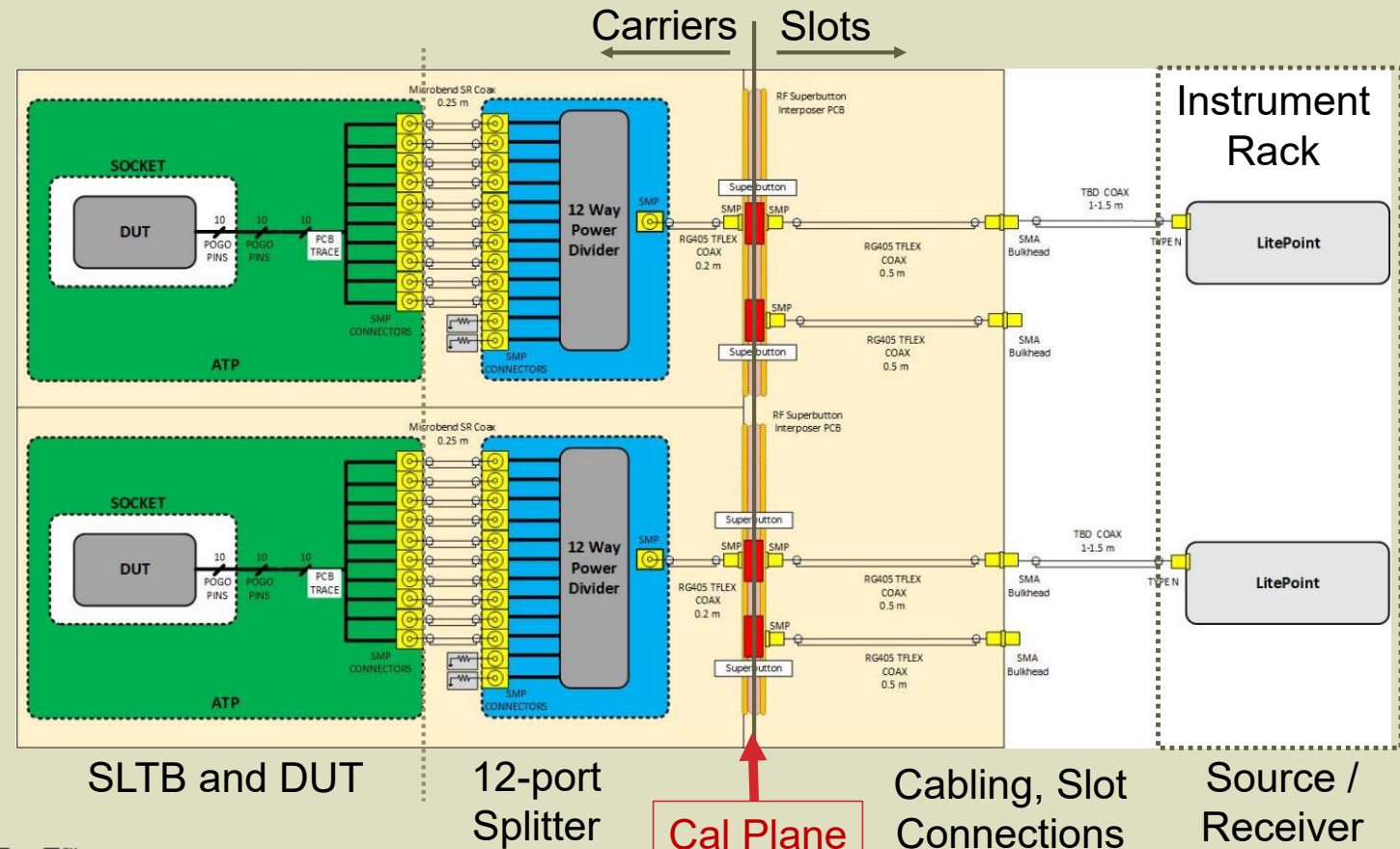
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RF Signal Path Architecture

Key Components:

- RF Source/Receiver
 - 1:4 sharing ratio
 - Housed in external racks
- Slot-side cables and connections
- Carrier cables and connections
- 12-port splitter in carrier
- SLT board and DUT

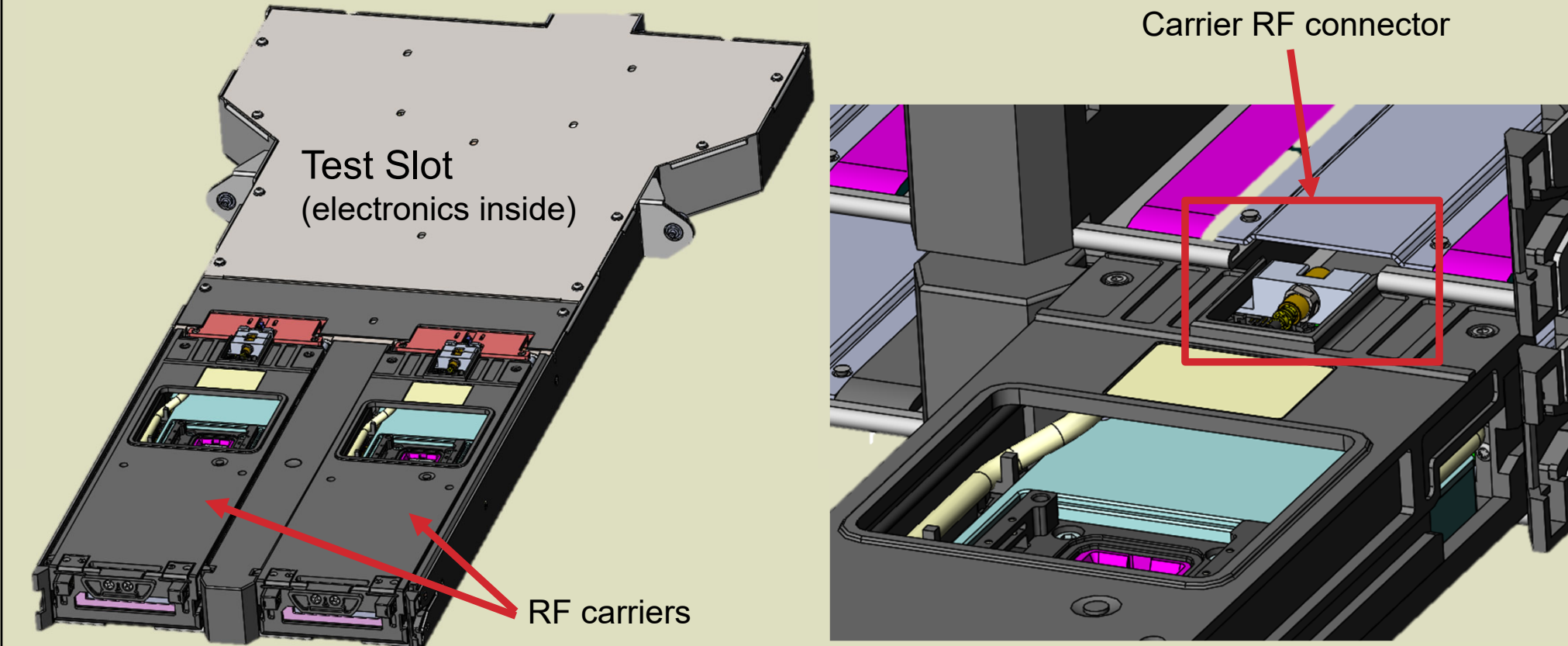


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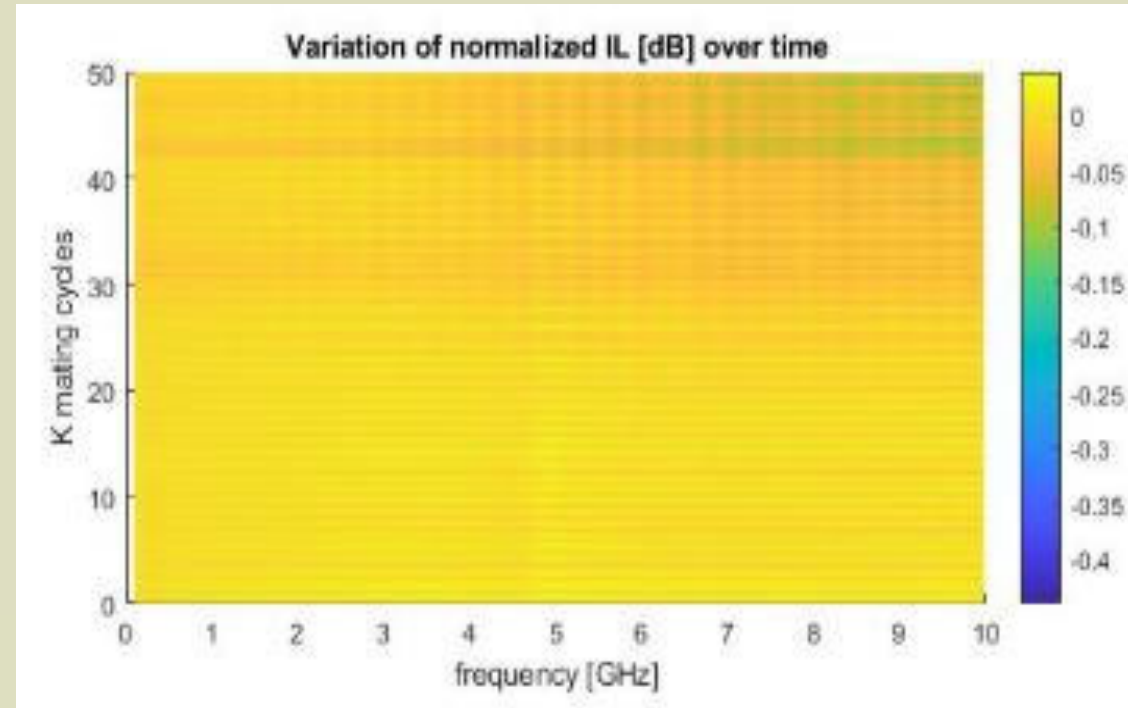
SLT/RF Carrier and Slot



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S21 Repeatability testing up to 50k mating cycles



0.05dB change up to **30k** cycles

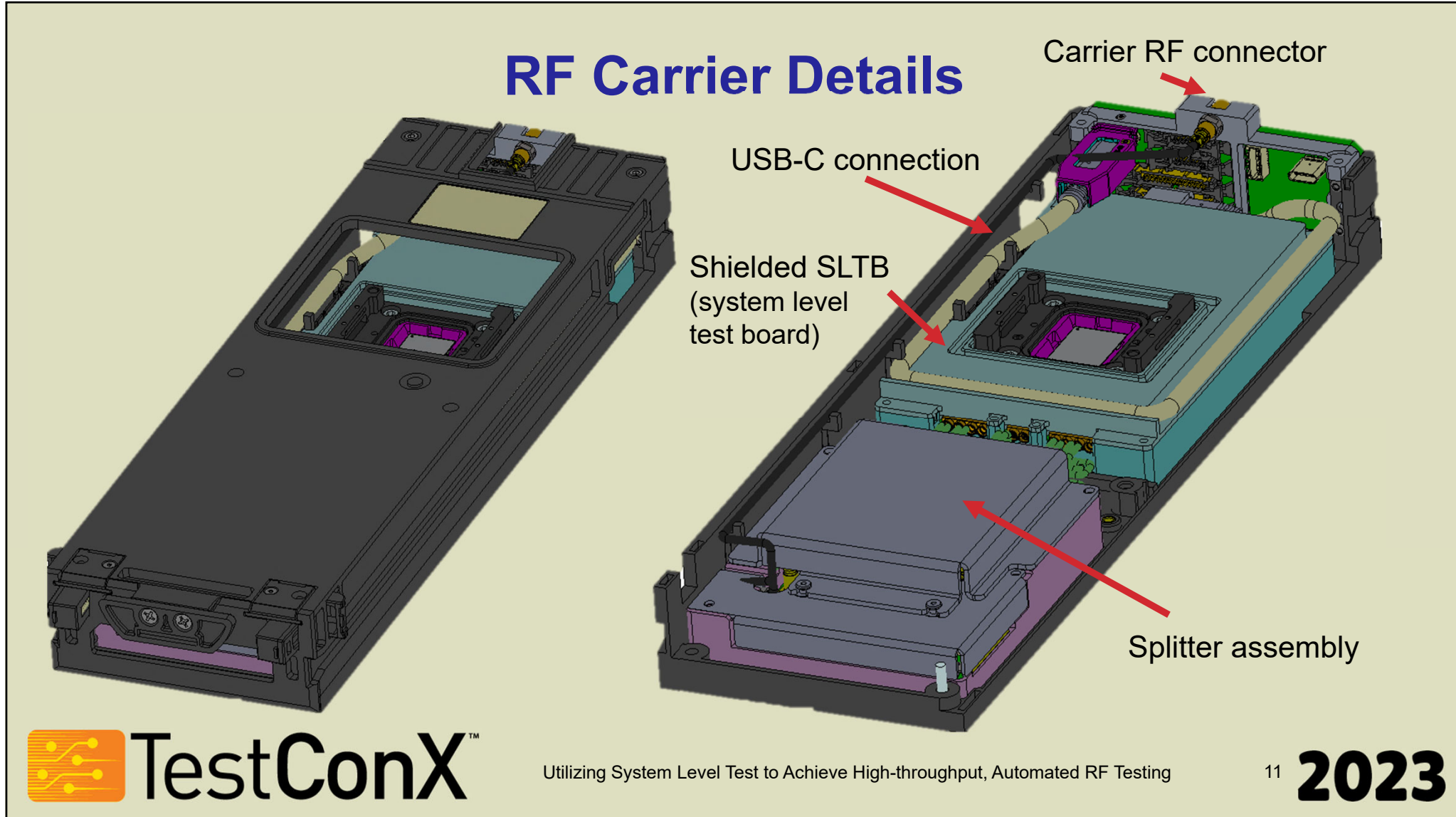
0.1dB change up to **50k** cycles



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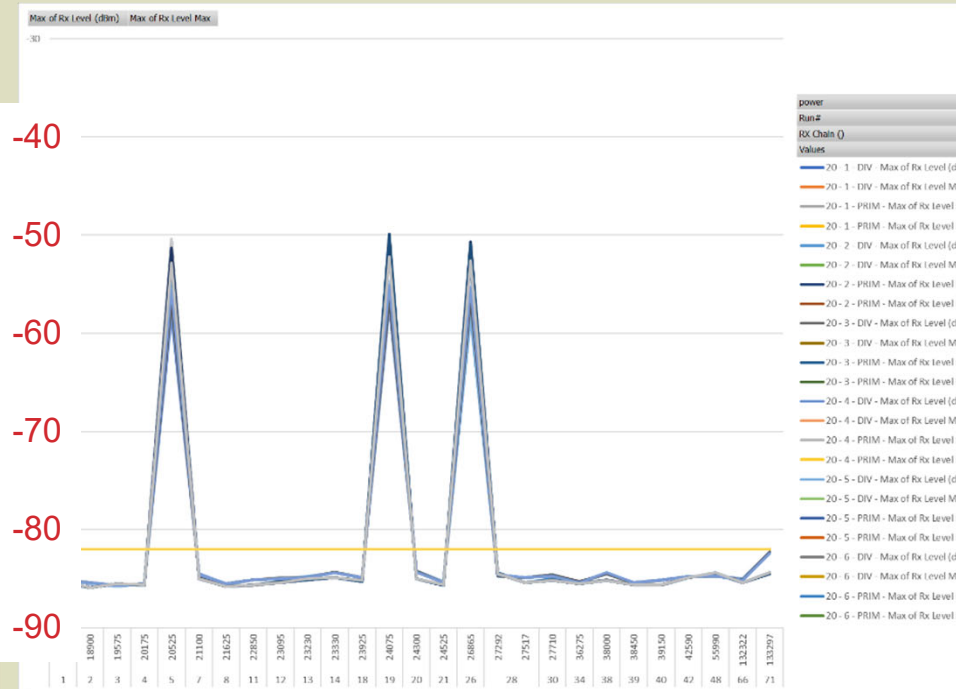
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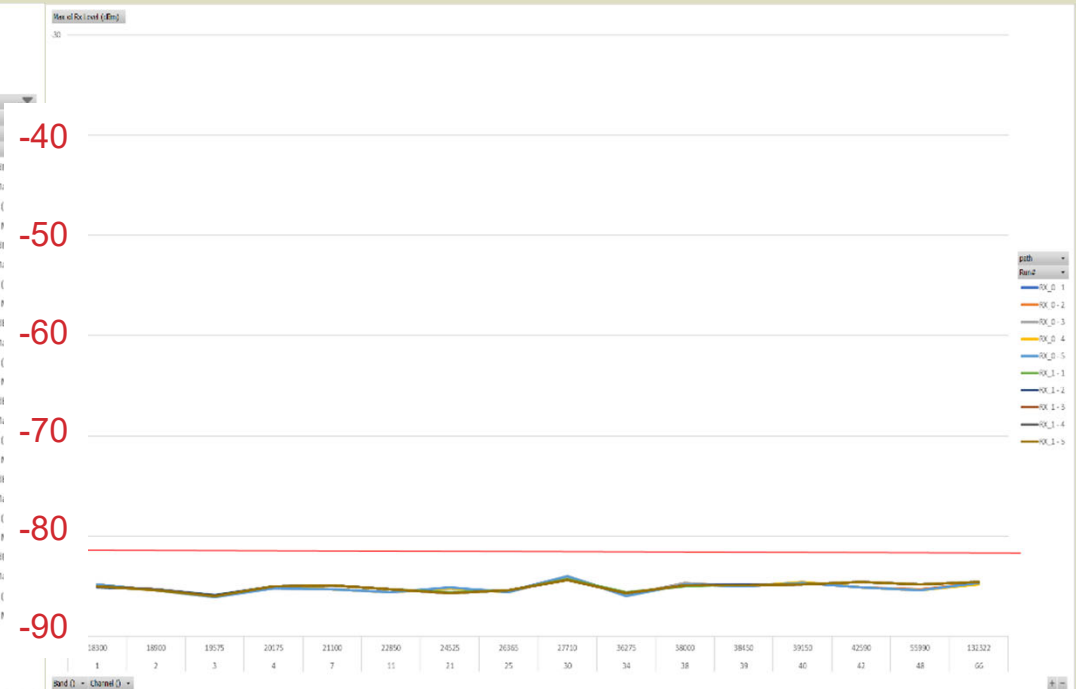


Example Shielding Test: Band 5 Interferer @ 882MHz

Unshielded baseline



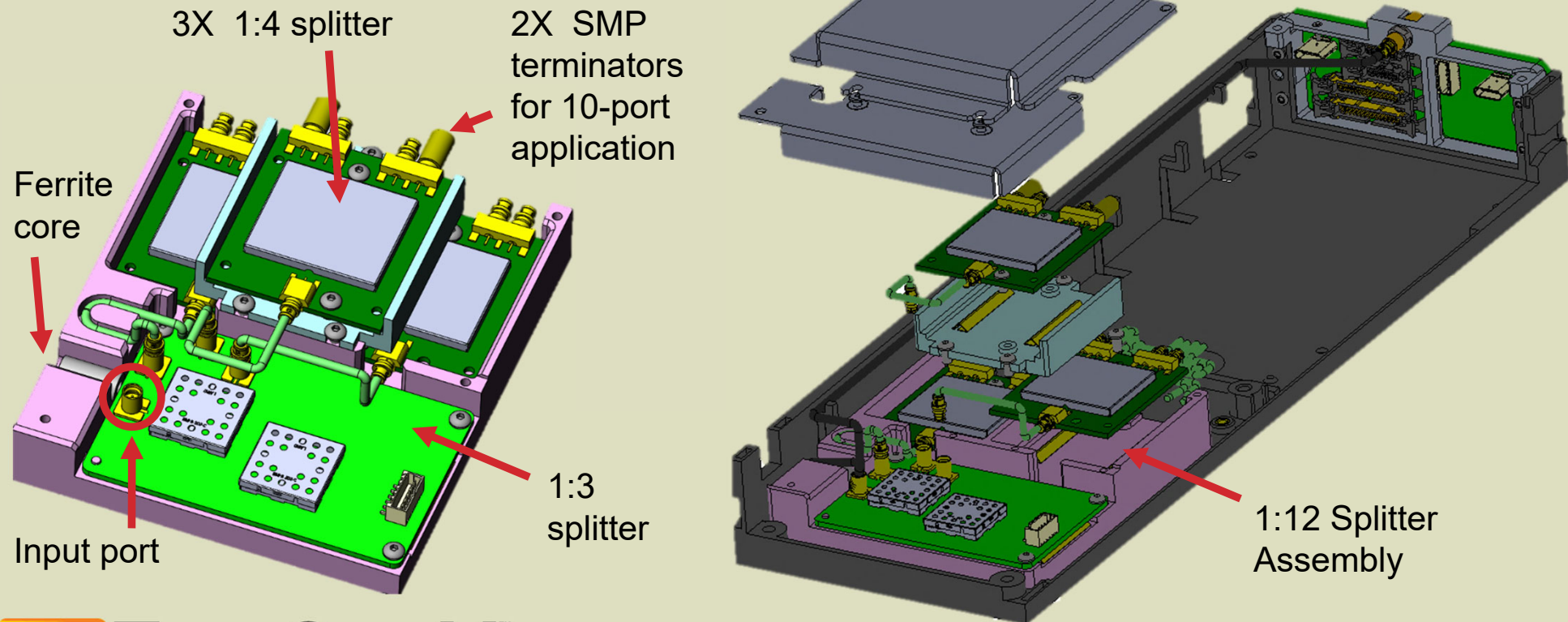
Shielded



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12-port Splitter



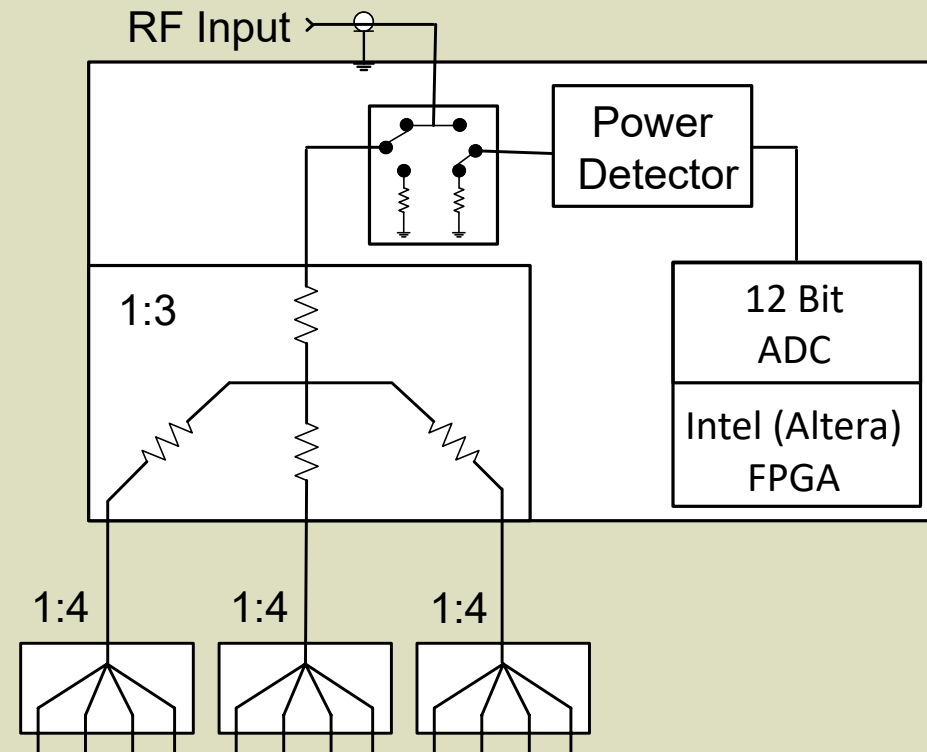
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RF Splitter Block Diagram

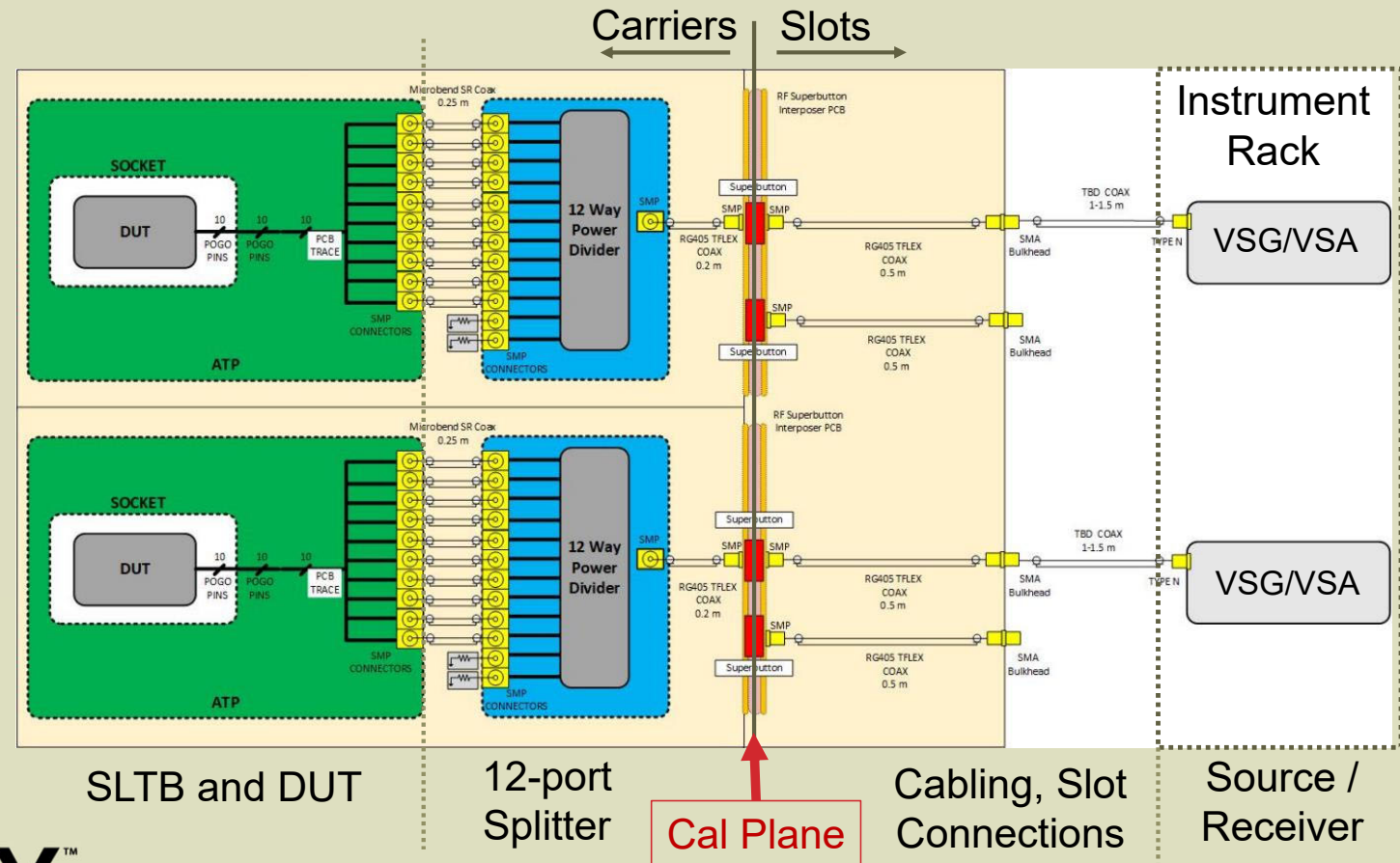
- **1:3 Resistive splitter**
 - Power Meter (Detector)
 - High-isolation RF switch to divert signal to power meter
 - Onboard temperature sensor
 - FPGA
 - Provides serial (I²C) interface to Slot hardware
 - Controls switch and enables Power Meter
 - Provides serial interface to temperature sensor
 - Internal ADC to measure power meter output
- **1:4 Splitter**
 - SMP Connectorized design
 - Low-loss Wilkinson design



Calibration Strategy

Calibration steps:

- Measure both sides of the Cal plane, store the values in memory
- Cal values from the SLTB, Carrier, and Slot are added together for each test
- Slot side measured with Cal carrier
- Carrier side measured during manufacturing



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Key benefits of an SLT RF Platform

- Ability to perform parallel testing with high site count while still meeting RF test requirements with high repeatability and less human error
- Achieve significant floor space savings
- Achieve operator labor savings
- Maximize the device RF performance by characterizing the device in the final system level application environment



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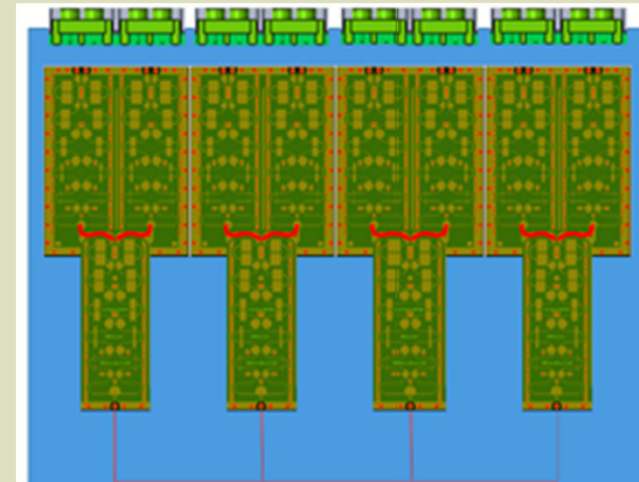
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Where do we go from here?

- New use cases
 - Make wireless call to system integrated “cell tower”
 - Connect wirelessly to GPS repeater integrated into the system
- Additional instruments
 - Application-specific electronics in the carrier
- Roadmap technical enhancements
 - Support for additional antennas per device
 - 5G bands up to 8GHz
 - Signal amplifier



Acknowledgements

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